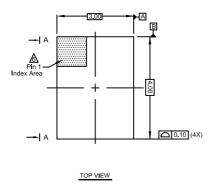
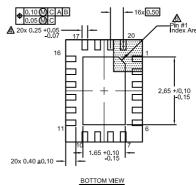
## **Plastic Packages for Integrated Circuits**

## **Package Outline Drawing**

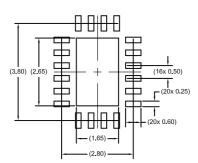
20 Lead Thin Quad Flat No-lead Plastic Package (TQFN)

Rev 1, 11/2021

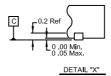




VIEW"A-A"



See Detail "X" // 0.10 C 0.80 Max eating Plane SIDE VIEW



TYPICAL RECOMMENDED LAND PATTERN

## NOTES:

- Dimensions are in millimeters.
  Dimensions in ( ) for Reference Only.
- 2. Dimensioning and tolerancing conform to AMSEY14.5m-1994.
- 3. Unless otherwise specified, tolerance : Decimal ±0.05
- 4. Dimension applies to the metallized terminal and is measured between 0.15mm and 0.30mm from the terminal tip.
- 5. Tiebar (if present) is a non-functional feature.
- 6. The configuration of the pin #1 identifier is optional, but must be located within the zone indicated. The pin #1 indentifier may be either a mold or mark feature.
- 7. Reference document JEDEC MO-220VEGD-NJI.